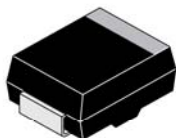


2.0Amp Super Fast Recovery Surface Mounted Rectifiers



ER2A TO ER2J

**DO-214AC (SMA)
Plastic Package
RoHS compliant**

DO-214AC (SMA)

FEATURES:

1. The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
2. Idea for printed circuit board
3. Glass passivated Junction chip
4. Low reverse leakage
5. High forward surge current capability
6. High temperature soldering guaranteed 250 °C/10 seconds at terminals

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	ER2A	ER2B	ER2C	ER2D	ER2F	ER2G	ER2J	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current at T _L =100 °C	I _(AV)	2.0							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	50.0							A
Maximum instantaneous forward voltage at 2.0A	V _F	0.95				1.25		1.7	V
Maximum DC reverse current T _A =25 °C	I _R	5.0							uA
at rated DC blocking voltage T _A =125 °C		500							
Maximum reverse recovery time(Note 1)	T _{rr}	35							ns
Typical junction capacitance (Note2)	C _J	55.0							pF
Typical thermal resistance	R _{qJA}	80.0							°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150							°C

Note:

1. Reverse recovery time test condition: $I_F = 0.5\text{A}$ $I_R = 1.0\text{A}$ $I_{rr} = 0.25\text{A}$
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

ER2A TO ER2J

Rev01_20082020ESW

TYPICAL CHARACTERISTICS CURVES

Fig 1: DERATING CURVE OUTPUT RECTIFIED CURRENT

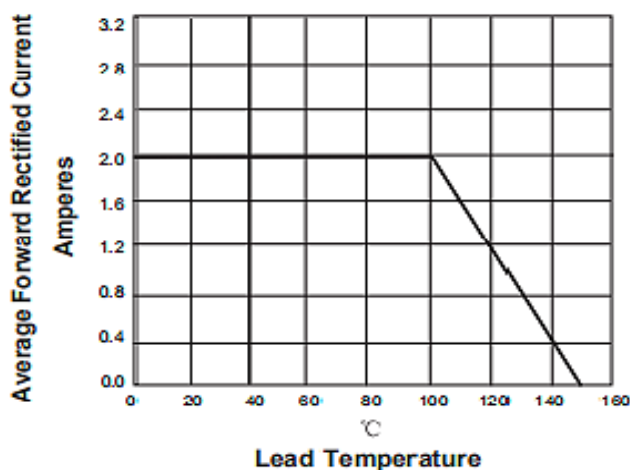


Fig 2: MAXIMUM NON-REPETITIVE PEAK FORWARDSURGE CURRENT PERLEG

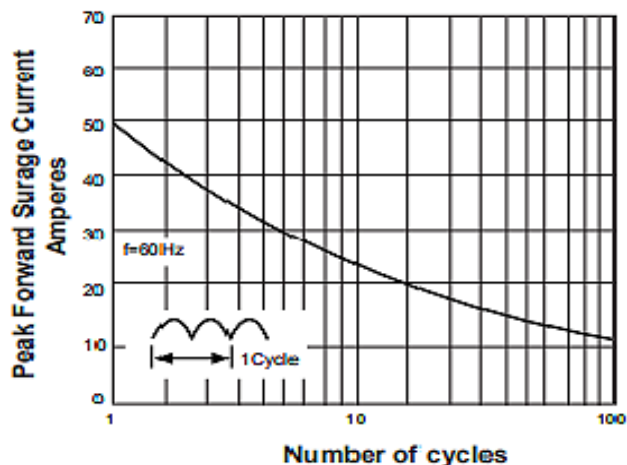


Fig 3: TYPICAL FORWARD VOLTAGE CHARACTERISTICS

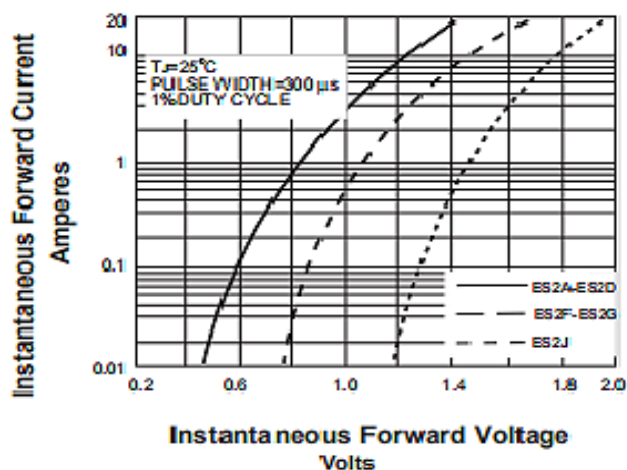
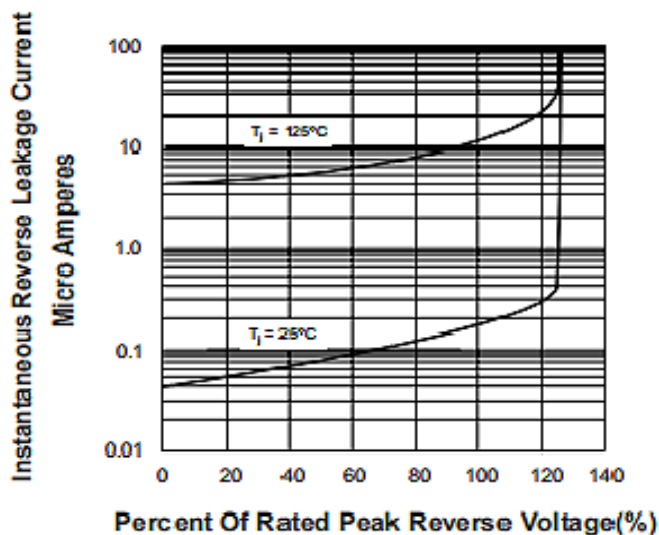


Fig 4: TYPICAL REVERSE LEAKAGE CHARACTERISTICS





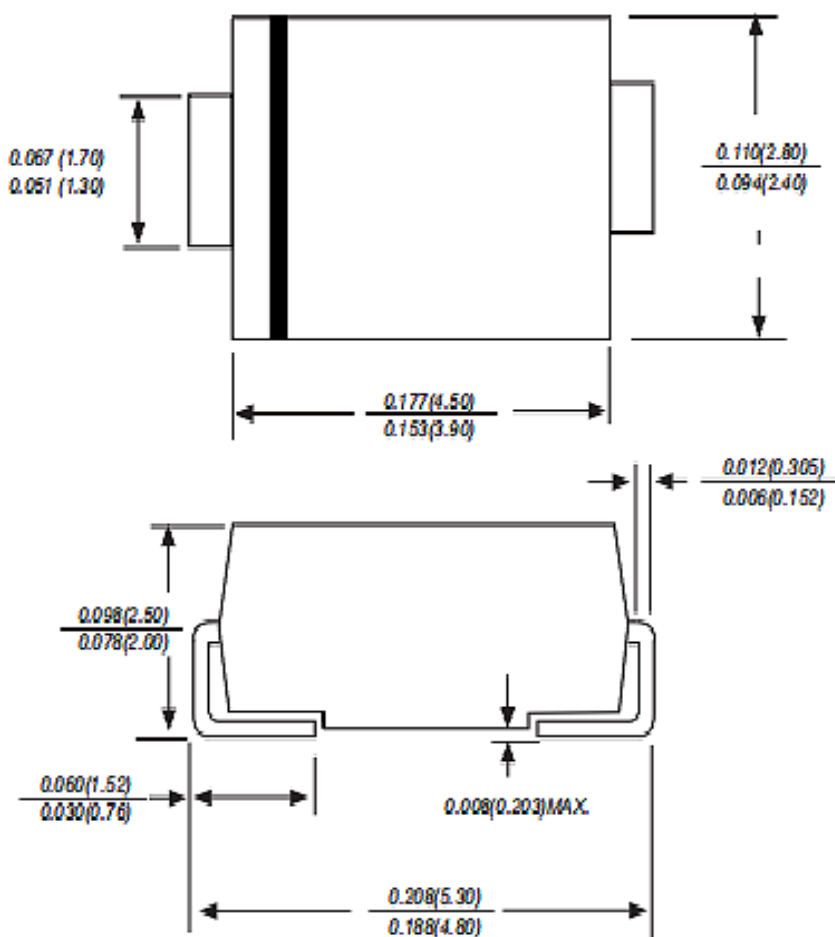
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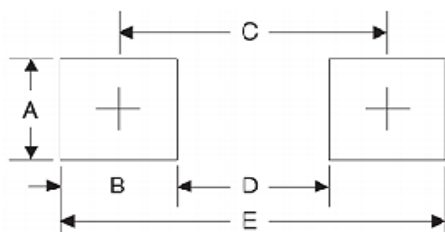
PACKAGE DETAILS

DO-214AC (SMA) SMD Plastic Package



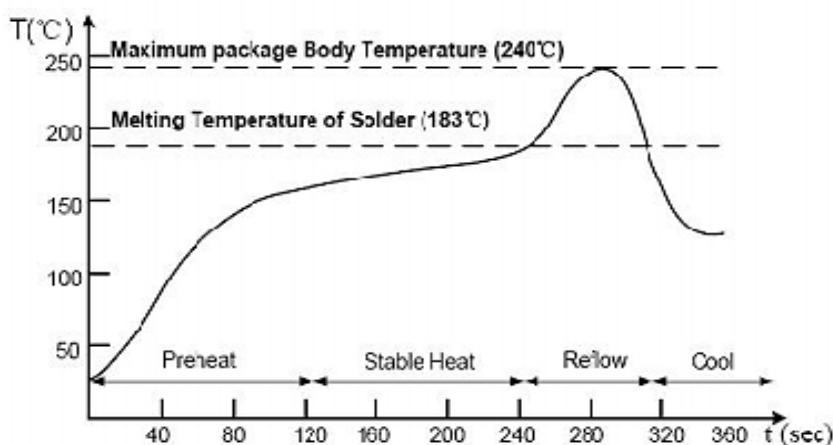
ER2A TO ER2J
Rev01_20082020ESW

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
B	1.52	0.060
C	3.90	0.154
D	2.41	0.095
E	5.45	0.215

Suggested Soldering Temperature Profile

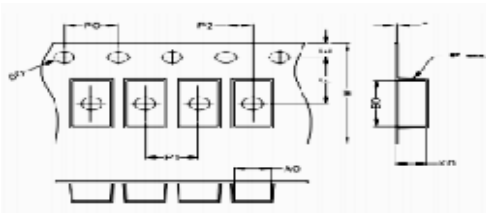


Note:

1. Recommend reflow method: IR, vapor phase oven, hot air oven, wave solder.
2. The device can be exposed to a maximum temperature of 265°C for 10 seconds.
3. Devices can be cleaned using standard industry method and solvents.
4. If reflow temperatures exceed the recommended profile, devices may not meet the performance

Package Information

Carrier Dimension(mm)



A0	B0	K0	D0	E	F
2.80	5.30	2.36	1.55	1.75	5.50
P0	P1	P2	T	W	Tolerance
4.0	4.0	2.0	0.25	12	0.1

Package Specifications

Package	Reel Size	Reel DIA. (mm)	Q'TY/Reel (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
SMA	11'	278	5	285	10	355*310*310	80
	13'	330	7.5	340	15	360*360*360	120



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Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- Temperature 5 °C to 30 °C
- Humidity between 40 to 70 %RH
- Air should be clean.
- Avoid harmful gas or dust.
- Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- Avoid rapid change of temperature.
- Avoid condensation.
- Mechanical stress such as vibration and impact shall be avoided.
- The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level		
Level	Time	Condition
1	Unlimited	≤30 °C / 85% RH
2	1 Year	≤30 °C / 60% RH
2a	4 Weeks	≤30 °C / 60% RH
3	168 Hours	≤30 °C / 60% RH
4	72 Hours	≤30 °C / 60% RH
5	48 Hours	≤30 °C / 60% RH
5a	24 Hours	≤30 °C / 60% RH
6	Time on Label(TOL)	≤30 °C / 60% RH

ER2A TO ER2J

Rev01_20082020ESW



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Customer Notes

Component Disposal Instructions

1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving /support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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ER2A TO ER2J

Rev01_20082020ESW